Docket No.: TOYAM83.001APC



Customer No.: 20,995

TC 17

AMENDMENT / RESPONSE TRANSMITTAL

Applicant

: Yamashita, et al.

App. No.

10/019,753

Filed

: March 5, 2002

For

LOW-HYGROSCOPICITY

LOW-BIREFRINGENCE RESIN COMPOSITIONS,

MOLDING MATERIAL OBTAINED THEREFROM,

SHEET OR FILM, AND

OPTICAL PART

Examiner

Rip A. Lee

Art Unit

1713

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

November 17, 2003

(Date)

Che Swyden Chereskin, Ph.D., Reg. No. 41,466

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Transmitted herewith for filing in the above-identified application are the following enclosures:

- (X) Supplemental Amendment in 4 pages.
- (X) Return prepaid postcard.
- (X) Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

Che Swyden Chereskin, Ph.D.

Registration No. 41,466

Agent of Record

Customer No. 20,995

(949) 760-0404

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Examiner

Lee, Rip A.

Group Art Unit: 1713

SUPPLEMENTAL AMENDMENT

United States Patent and Trademark Office PO Box 1450, Alexandria, VA 22313-1450

Dear Sir:

This amendment is supplemental to the Amendment filed on October 24, 2003. Applicants respectfully request the Examiner to enter the following amendments.